

06-24-2004



6.6001

	76084 U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office		
To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.			
1. Name of conveying party(ies): Jimmy CHEW HWEE Seng XIA Dingwei	2. Name and address of receiving party(ies) Name: ADVANCED SYSTEMS AUTOMATION Internal Address: NVA		
Additional name(s) of conveying party(les) attached? Yes			
3. Nature of conveyance: Assignment Merger Security Agreement Change of Nature Other	Street Address: 54 Serangoon North Puenue 4 City: Singapore State: Zip: 555854		
Execution Date: 27 may 2004	Additional name(s) & address(es) attached? Yes No		
If this document is being filed together with a new application, the execution date of the application is: A. Patent Application No.(s) 10 149 1 687 B. Patent No.(s) B. Patent No.(s) Additional numbers attached? Tyes No			
Name and address of party to whom corresponde concerning document should be mailed:	ence 6. Total number of applications and patents involved:		
Name: GEORGE D. LIU	7. Total fee (37 CFR 3.41)\$ 40.00		
Internal Address:	. Enclosed Authorized to be charged to deposit account		
Street Address: 2101 CRYSTAL PLAZA ARC,	8. Deposit account number:		
City: ARLINGTON State: VA Zip: 22202			
DO NOT USE THIS SPACE			
9. Signature. GEORGE D. LIU	A) / 14 June 2004		
Name of Person Signing	Signature Date		
Total number of pages includin	g cover sheet, attachments, and documents:		

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments

Washington, D.C. 20231

1 00000026 10491687

AA AA

40.00 OP

ASSIGNMENT OF INVENTION

In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

ASSIGNORS:

Jimmy CHEW Hwee Seng 3A Siglap Terrace, Singapore 455289

XIA Dingwei Blk 766 Yishun Ave 3, #11-303, Singapore 760766

hereby sell, assign and transfer to

ASSIGNEES:

ADVANCED SYSTEMS AUTOMATION LTD 54 Serangoon North Avenue 4, Singapore 555854

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions and in all foreign countries, including all rights to claim priority, in and to all improvements which are disclosed in the invention entitled:

APPARATUS FOR MOLDING A SEMICONDUCTOR WAFER AND PROCESS THEREFOR

which has been executed by the undersigned concurrently herewith			
which was filed on 2 Apr 2004	and assigned Serial No. 10	491687	

and, in and to all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, substitute, reissue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

1007.P046US/KJT/ayu

PATENT REEL: 015488 FRAME: 0281 ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, We hereunto set hand and seal

27/5/2004

Date

- h - 1/2

Date

XIA Dingwei

EW Hwee Seng

1007.P046US/KJT/ayu